

# Summit Wireless Technologies to Participate in Upcoming Investor Conferences

SAN JOSE, Calif.--(BUSINESS WIRE)-- [Summit Wireless Technologies, Inc.](#) (NASDAQ: WISA), a leading provider of immersive, wireless sound technology for intelligent devices and next-generation home entertainment systems, announced its management team is scheduled to participate in the following conferences in December 2019.

December 4 Benchmark's 8<sup>th</sup> Annual Discovery 1 x 1 Conference  
The New York Athletic Club, New York City  
1x1 meetings

December 10 LD Micro Main Event  
The Luxe Sunset Boulevard Hotel, Los Angeles,  
California  
Presentation at 2:20 p.m. PT, 1x1 meetings

Presentation materials will be posted on the Investor Relations portion of the company's website at [www.summitwireless.com](http://www.summitwireless.com). Interested parties may contact their representatives at the above firms to arrange meetings at the respective events

## About Summit Wireless Technologies, Inc.

Summit Wireless Technologies, Inc. (NASDAQ: WISA) is a leading provider of immersive, wireless sound technology for intelligent devices and next generation home entertainment systems. Working with leading CE brands and manufacturers such as Harman International, a division of Samsung, LG Electronics, Klipsch, Bang & Olufsen, Xbox, a subsidiary of Microsoft, and others, Summit Wireless delivers seamless, dynamic audio experiences for high-definition content, including movies and video, music, sports, gaming/esports, and more. Summit Wireless is a founding member of WiSA, the Wireless Speaker and Audio Association and works in joint partnership to champion the most reliable interoperability standards across the audio industry. Summit Wireless, formerly named Summit Semiconductor, Inc., is headquartered in San Jose, CA with sales teams in Taiwan, China, Japan, and Korea. For more information, please visit: [www.summitwireless.com](http://www.summitwireless.com).

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